AiP74HC/HCT191
Presettable Synchronous 4-bit Binary
up/down Counter

Product   Specification

Specification Revision History：

Version	Date	Description
2012-06-A1	2012-06	New
2023-04-B1	2023-04	Update the template

Contents

1、General Description

The AiP74HC/HCT191 is an asynchronously presettable 4-bit binary up/down counter. It contains four master/slave flip-flops with internal gating and steering logic to provide asynchronous preset and synchronous count-up and count-down operation.

Asynchronous parallel load capability permits the counter to be preset to any desired value. Information present on the parallel data inputs (D0 to D3) is loaded into the counter and appears on the outputs when the parallel load ($\overline{PL}$) input is LOW. This operation overrides the counting function.

Counting is inhibited by a HIGH level on the count enable ($\overline{CE}$) input. When $\overline{CE}$ is LOW internal state changes are initiated synchronously by the LOW-to-HIGH transition of the clock input. The up/down ($\overline{U}$/D) input signal determines the direction of counting as indicated in the function table. The $\overline{CE}$ input may go LOW when the clock is in either state, however, the LOW-to-HIGH $\overline{CE}$ transition must occur only when the clock is HIGH.

Also, the $\overline{U}$/D input should be changed only when either $\overline{CE}$ or CP is HIGH. Overflow/underflow indications are provided by two types of outputs, the terminal count (TC) and ripple clock ($\overline{RC}$). The TC output is normally LOW and goes HIGH when a circuit reaches zero in the count-down mode or reaches '15' in the count-up-mode. The TC output will remain HIGH until a state change occurs, either by counting or presetting, or until $\overline{U}$/D is changed. Do not use the TC output as a clock signal because it is subject to decoding spikes. The TC signal is used internally to enable the $\overline{RC}$ output. When TC is HIGH and $\overline{CE}$ is LOW, the $\overline{RC}$ output follows the clock pulse (CP). This feature simplifies the design of multistage counters as shown in Figure 4 and Figure 5.

In Figure 4, each $\overline{RC}$ output is used as the clock input to the next higher stage. It is only necessary to inhibit the first stage to prevent counting in all stages, since a HIGH on $\overline{CE}$ inhibits the $\overline{RC}$ output pulse as indicated in the function table. The timing skew between state changes in the first and last stages is represented by the cumulative delay of the clock as it ripples through the preceding stages. This can be a disadvantage of this configuration in some applications.

Figure 5 shows a method of causing state changes to occur simultaneously in all stages. The $\overline{RC}$ outputs propagate the carry/borrow signals in ripple fashion and all clock inputs are driven in parallel. In this configuration the duration of the clock LOW state must be long enough to allow the negative-going edge of the carry/borrow signal to ripple through to the last stage before the clock goes HIGH. Since the $\overline{RC}$ output of any package goes HIGH shortly after its CP input goes HIGH there is no such restriction on the HIGH-state duration of the clock.

In Figure 6, the configuration shown avoids ripple delays and their associated restrictions. Combining the TC signals from all the preceding stages forms the $\overline{CE}$ input for a given stage. An enable must be included in each carry gate in order to inhibit counting. The TC output of a given stage it not affected by its own $\overline{CE}$ signal therefore the simple inhibit scheme of Figure 4 and 5 does not apply. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC}.

Features:

- Input levels:
    For AiP74HC191: CMOS level
    For AiP74HCT191: TTL level
- Synchronous reversible counting
- Asynchronous parallel load
- Count enable control for synchronous expansion
- Single up/down control input
- Specified from -40℃ to +125℃
- Packaging information: DIP16/SOP16/TSSOP16

Ordering Information:

Tube packing specifications:

Part number	Packaging form	Marking code	Tube quantity	Boxed tube quantity	Boxed quantity	Notes
AiP74HC191DA16.TB	DIP16	74HC191	25 PCS/tube	40 tube/box	1000 PCS/box	Dimensions of plastic enclosure: 19.0mm×6.4mm Pin spacing: 2.54mm
AiP74HCT191DA16.TB	DIP16	74HCT191	25 PCS/tube	40 tube/box	1000 PCS/box	Dimensions of plastic enclosure: 19.0mm×6.4mm Pin spacing: 2.54mm
AiP74HC191SA16.TB	SOP16	74HC191	50 PCS/tube	200 tube/box	10000 PCS/box	Dimensions of plastic enclosure: 10.0mm×3.9mm Pin spacing: 1.27mm
AiP74HCT191SA16.TB	SOP16	74HCT191	50 PCS/tube	200 tube/box	10000 PCS/box	Dimensions of plastic enclosure: 10.0mm×3.9mm Pin spacing: 1.27mm
AiP74HC191TA16.TB	TSSOP16	74HC191	96 PCS/tube	200 tube/box	19200 PCS/box	Dimensions of plastic enclosure: 5.0mm×4.4mm Pin spacing: 0.65mm
AiP74HCT191TA16.TB	TSSOP16	74HCT191	96 PCS/tube	200 tube/box	19200 PCS/box	Dimensions of plastic enclosure: 5.0mm×4.4mm Pin spacing: 0.65mm

Reel packing specifications:

Part number	Packaging form	Marking code	Reel quantity	Boxed reel quantity	Notes
AiP74HC191SA16.TR	SOP16	74HC191	4000 PCS/reel	8000 PCS/box	Dimensions of plastic enclosure: 10.0mm×3.9mm Pin spacing:1.27mm
AiP74HCT191SA16.TR	SOP16	74HCT191	4000 PCS/reel	8000 PCS/box	Dimensions of plastic enclosure: 10.0mm×3.9mm Pin spacing:1.27mm
AiP74HC191TA16.TR	TSSOP16	74HC191	5000 PCS/reel	10000 PCS/box	Dimensions of plastic enclosure: 5.0mm×4.4mm Pin spacing:0.65mm
AiP74HCT191TA16.TR	TSSOP16	74HCT191	5000 PCS/reel	10000 PCS/box	Dimensions of plastic enclosure: 5.0mm×4.4mm Pin spacing:0.65mm

Note: If the physical information is inconsistent with the ordering information, please refer to the actual product.

2、Block Diagram And Pin Description

2.1、Block Diagram

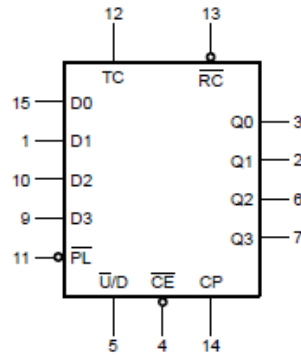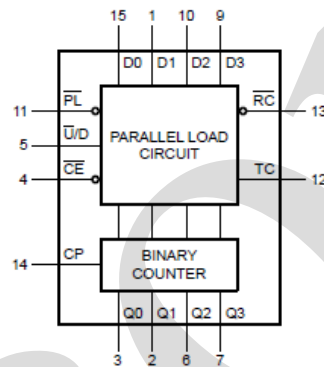Figure 1. Logic symbol

Figure 2. Functional diagram
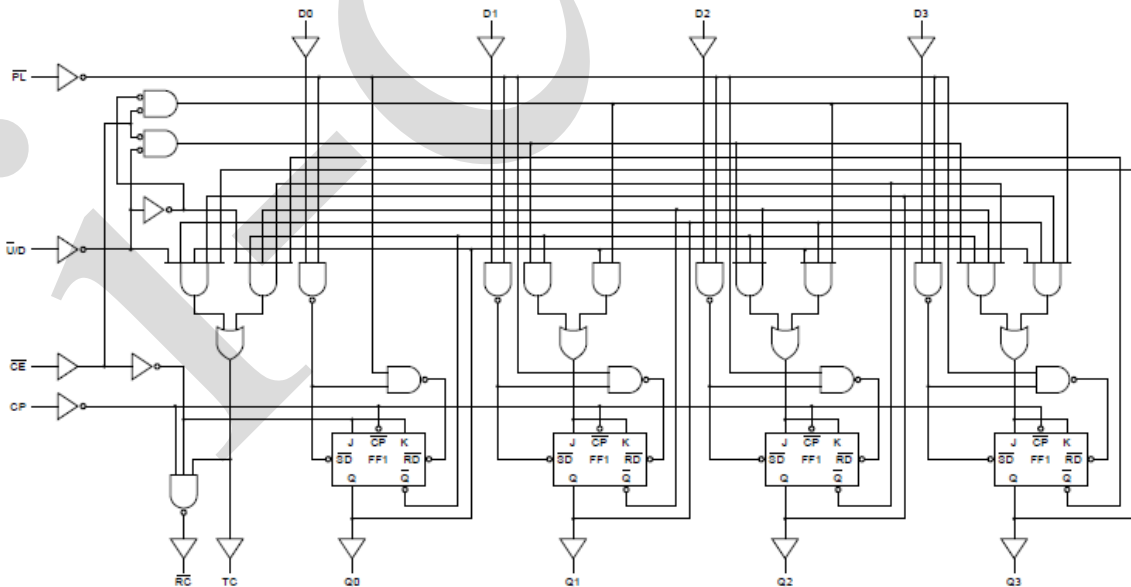
Figure 3. Logic diagram
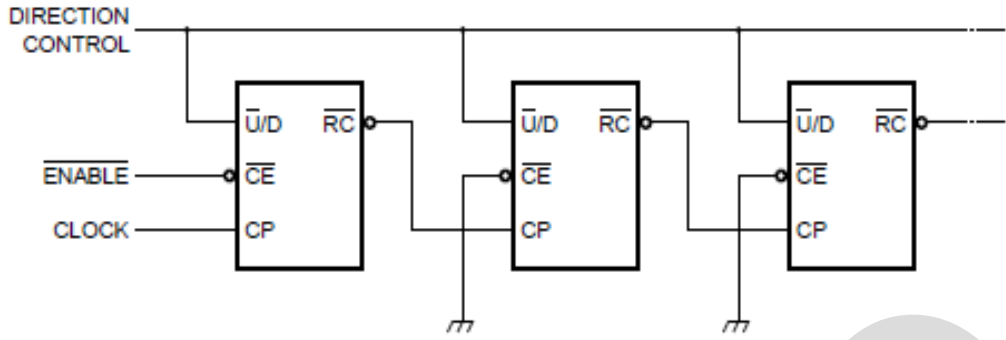
Figure 4. N-stage ripple counter using ripple clock
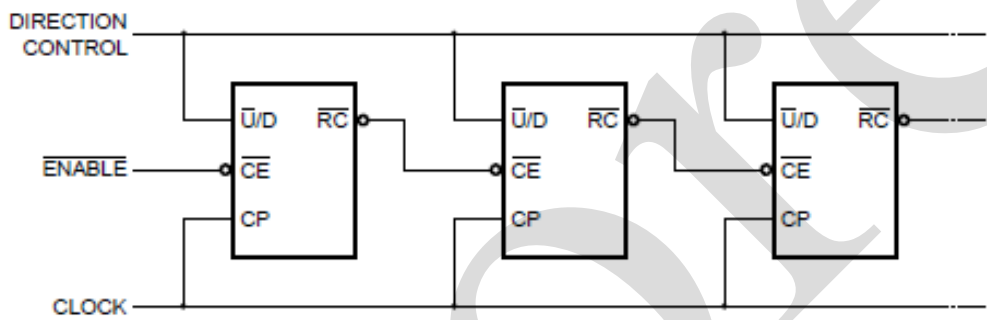
Figure 5. Synchronous n-stage counter using ripple carry/borrow
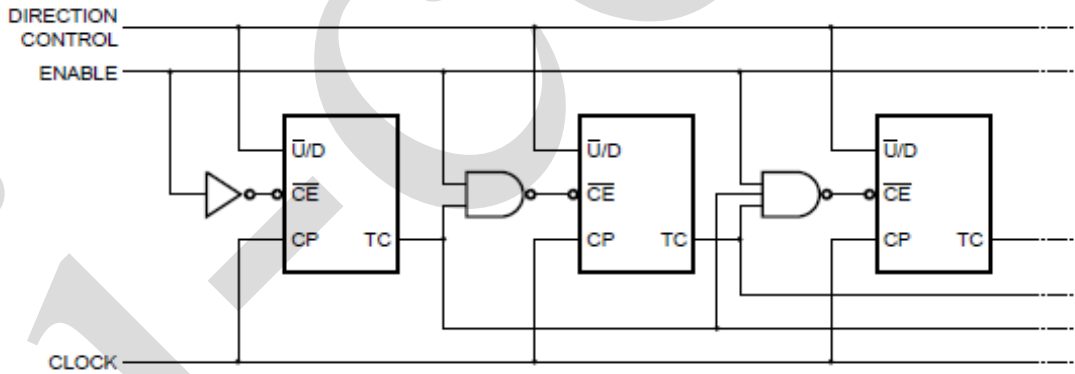
Figure 6. Synchronous n-stage counter with parallel gated carry/borrow
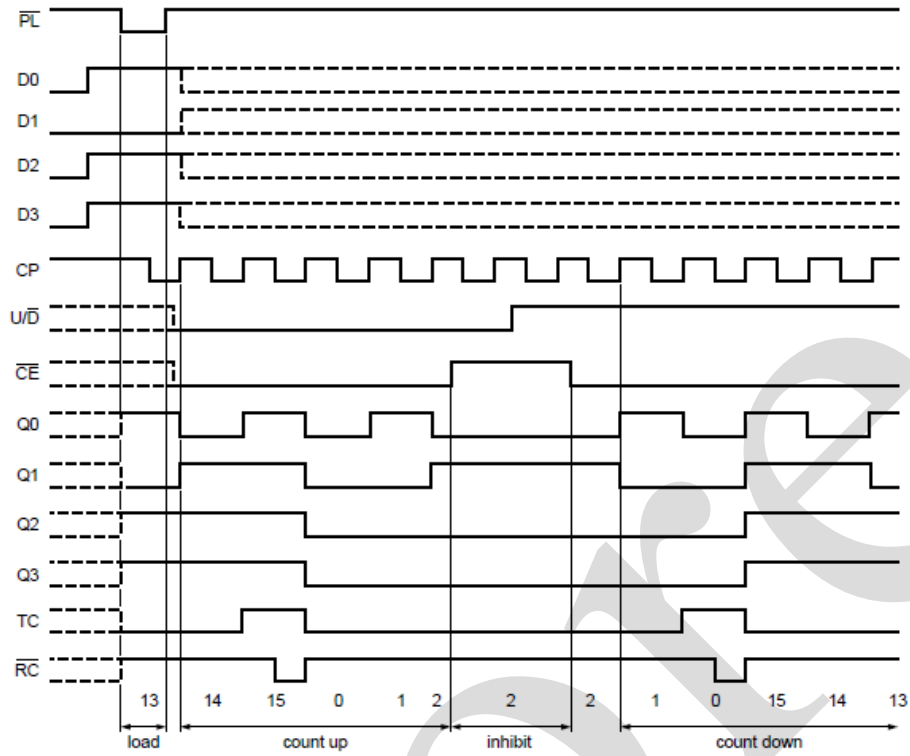
Figure 7. Typical timing sequence

2.2、Pin Configurations
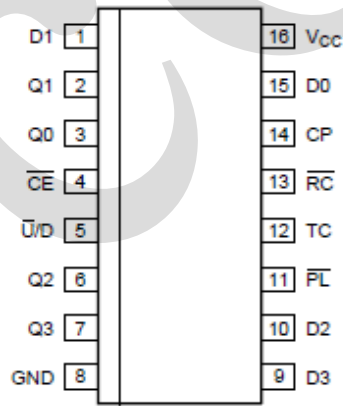
2.3、Pin Description

Pin No.	Pin Name	Description
1	D1	data input
2	Q1	flip-flop output
3	Q0	flip-flop output
4	$\overline{CE}$	count enable input (active LOW)
5	$\overline{U}/D$	up/down input
6	Q2	flip-flop output
7	Q3	flip-flop output
8	GND	ground (0V)
9	D3	data input
10	D2	data input
11	$\overline{PL}$	parallel load input (active LOW)
12	TC	terminal count output
13	$\overline{RC}$	ripple clock output (active LOW)
14	CP	clock input (LOW-to-HIGH, edge-triggered)
15	D0	data input
16	V_{CC}	supply voltage

2.4、Function Table

Operating mode	Input					Output
	$\overline{PL}$	$\overline{U}/D$	$\overline{CE}$	CP	Dn	Qn
parallel load	L	X	X	X	L	L
	L	X	X	X	H	H
count up	H	L	1	↑	X	count up
count down	H	H	1	↑	X	count down
hold (do nothing)	H	X	H	X	X	no change

Note: H=HIGH voltage level; L=LOW voltage level; X=don't care; ↑=LOW-to-HIGH clock transition;

l=LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition.

Input			Terminal count state				Output	
$\overline{U}/D$	$\overline{CE}$	CP	Q0	Q1	Q2	Q3	TC	$\overline{RC}$
H	H	X	H	H	H	H	L	H
L	H	X	H	H	H	H	H	H
L	L	⊔⌐	H	H	H	H	⌐⌐	⊔⌐
L	H	X	L	L	L	L	L	H
H	H	X	L	L	L	L	H	H
H	L	⊔⌐	L	L	L	L	⌐⌐	⊔⌐

Note:

[1] H=HIGH voltage level; L=LOW voltage level; X=don't care.

[2] ⊔⌐ =one LOW level output pulse.

[3] ⌐ =TC goes LOW on a LOW-to-HIGH clock transition.

3、Electrical Parameter

3.1、Absolute Maximum Ratings

(Voltages are referenced to GND(ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Max.	Unit
supply voltage	V_{CC}	-		-0.5	+7.0	V
input clamping current	I_{IK}	$V_I < -0.5V$ or $V_I > V_{CC}+0.5V$		-	±20	mA
output clamping current	I_{OK}	$V_O < -0.5V$ or $V_O > V_{CC}+0.5V$		-	±20	mA
output current	I_O	$V_O= -0.5V$ to $V_{CC}+0.5V$		-	±25	mA
supply current	I_{CC}	-		-	+50	mA
ground current	I_{GND}	-		-50	-	mA
storage temperature	T_{stg}	-		-65	+150	℃
total power dissipation	P_{tot}	-		-	500	mW
Soldering temperature	T_L	10s	DIP	245		℃
			SOP/TSSOP	260		

3.2、Recommended Operating Conditions

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
AiP74HC191						
supply voltage	V_{CC}	-	2.0	5.0	6.0	V
input voltage	V_I	-	0	-	V_{CC}	V
output voltage	V_O	-	0	-	V_{CC}	V
input transition rise and fall rate	$\Delta t/\Delta V$	V_{CC}=2.0V	-	-	625	ns/V
		V_{CC}=4.5V	-	1.67	139	ns/V
		V_{CC}=6.0V	-	-	83	ns/V
ambient temperature	T_{amb}	-	-40	-	+125	℃
AiP74HCT191						
supply voltage	V_{CC}	-	4.5	5.0	5.5	V
input voltage	V_I	-	0	-	V_{CC}	V
output voltage	V_O	-	0	-	V_{CC}	V
input transition rise and fall rate	$\Delta t/\Delta V$	V_{CC}=4.5V	-	1.67	139	ns/V
ambient temperature	T_{amb}	-	-40	-	+125	℃

3.3、Electrical Characteristics

3.3.1、DC Characteristics 1

(T_{amb}=25℃, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
AiP74HC191							
HIGH-level input voltage	V_{IH}		V_{CC}=2.0V	1.5	1.2	-	V
			V_{CC}=4.5V	3.15	2.4	-	V
			V_{CC}=6.0V	4.2	3.2	-	V
LOW-level input voltage	V_{IL}		V_{CC}=2.0V	-	0.8	0.5	V
			V_{CC}=4.5V	-	2.1	1.35	V
			V_{CC}=6.0V	-	2.8	1.8	V
HIGH-level output voltage	V_{OH}	$V_I = V_{IH}$ or V_{IL}	I_O=-20uA; V_{CC}=2.0V	1.9	2.0	-	V
			I_O=-20uA; V_{CC}=4.5V	4.4	4.5	-	V
			I_O=-20uA; V_{CC}=6.0V	5.9	6.0	-	V
			I_O=-4.0mA; V_{CC}=4.5V	3.98	4.32	-	V
			I_O=-5.2mA; V_{CC}=6.0V	5.48	5.81	-	V
LOW-level output voltage	V_{OL}	$V_I = V_{IH}$ or V_{IL}	I_O=20uA; V_{CC}=2.0V	-	0	0.1	V
			I_O=20uA; V_{CC}=4.5V	-	0	0.1	V
			I_O=20uA; V_{CC}=6.0V	-	0	0.1	V
			I_O=4.0mA; V_{CC}=4.5V	-	0.15	0.26	V
			I_O=5.2mA; V_{CC}=6.0V	-	0.16	0.26	V
input leakage current	I_I	V_I=V_{CC} or GND; V_{CC}=6.0V		-	-	±1.0	uA
supply current	I_{CC}	V_I=V_{CC} or GND; I_O=0A; V_{CC}=6.0V		-	-	8.0	uA
input capacitance	C_I	-		-	3.5	-	pF
AiP74HCT191							

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
HIGH-level input voltage	V_{IH}	V_{CC}=4.5V to 5.5V		2.0	1.6	-	V
LOW-level input voltage	V_{IL}	V_{CC}=4.5V to 5.5V		-	1.2	0.8	V
HIGH-level output voltage	V_{OH}	$V_I = V_{IH}$ or V_{IL}; V_{CC}=4.5V	I_O=-20uA	4.4	4.5	-	V
			I_O=-4.0mA	3.98	4.32	-	V
LOW-level output voltage	V_{OL}	$V_I = V_{IH}$ or V_{IL}; V_{CC}=4.5V	I_O=20uA	-	0	0.1	V
			I_O=4.0mA	-	0.16	0.26	V
input leakage current	I_I	V_I=V_{CC} or GND; V_{CC}=5.5V		-	-	±1.0	uA
supply current	I_{CC}	V_I=V_{CC} or GND; I_O=0A; V_{CC}=5.5V		-	-	8.0	uA
additional supply current	ΔI_{CC}	V_I=V_{CC}-2.1V; other inputs at V_{CC} or GND; I_O=0A; V_{CC}=4.5V to 5.5V		-	-	360	uA
input capacitance	C_I	-		-	3.5	-	pF

3.3.2、DC Characteristics 2

(T_{amb}=-40℃ to +85℃, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
AiP74HC191							
HIGH-level input voltage	V_{IH}	V_{CC}=2.0V		1.5	-	-	V
		V_{CC}=4.5V		3.15	-	-	V
		V_{CC}=6.0V		4.2	-	-	V
LOW-level input voltage	V_{IL}	V_{CC}=2.0V		-	-	0.5	V
		V_{CC}=4.5V		-	-	1.35	V
		V_{CC}=6.0V		-	-	1.8	V
HIGH-level output voltage	V_{OH}	$V_I = V_{IH}$ or V_{IL}	I_O=-20uA; V_{CC}=2.0V	1.9	-	-	V
			I_O=-20uA; V_{CC}=4.5V	4.4	-	-	V
			I_O=-20uA; V_{CC}=6.0V	5.9	-	-	V
			I_O=-4.0mA; V_{CC}=4.5V	3.84	-	-	V
			I_O=-5.2mA; V_{CC}=6.0V	5.34	-	-	V
LOW-level output voltage	V_{OL}	$V_I = V_{IH}$ or V_{IL}	I_O=20uA; V_{CC}=2.0V	-	-	0.1	V
			I_O=20uA; V_{CC}=4.5V	-	-	0.1	V
			I_O=20uA; V_{CC}=6.0V	-	-	0.1	V
			I_O=4.0mA; V_{CC}=4.5V	-	-	0.33	V
			I_O=5.2mA; V_{CC}=6.0V	-	-	0.33	V
input leakage current	I_I	V_I=V_{CC} or GND; V_{CC}=6.0V		-	-	±1.0	uA
supply current	I_{CC}	V_I=V_{CC} or GND; I_O=0A; V_{CC}=6.0V		-	-	80	uA
AiP74HCT191							
HIGH-level input voltage	V_{IH}	V_{CC}=4.5V to 5.5V		2.0	-	-	V
LOW-level input voltage	V_{IL}	V_{CC}=4.5V to 5.5V		-	-	0.8	V
HIGH-level output voltage	V_{OH}	$V_I = V_{IH}$ or V_{IL}; V_{CC}=4.5V	I_O=-20uA	4.4	-	-	V
			I_O=-4.0mA	3.84	-	-	V

LOW-level output voltage	V_{OL}	$V_I = V_{IH}$ or V_{IL}; V_{CC}=4.5V	I_O=20uA	-	-	0.1	V
			I_O=4.0mA	-	-	0.33	V
input leakage current	I_I	V_I=V_{CC} or GND; V_{CC}=5.5V		-	-	±1.0	uA
supply current	I_{CC}	V_I=V_{CC} or GND; I_O=0A; V_{CC}=5.5V		-	-	80	uA
additional supply current	ΔI_{CC}	V_I=V_{CC}-2.1V; other inputs at V_{CC} or GND; I_O=0A; V_{CC}=4.5V to 5.5V		-	-	450	uA

3.3.3、DC Characteristics 3

(T_{amb}=-40℃ to +125℃, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
AiP74HC191							
HIGH-level input voltage	V_{IH}	V_{CC}=2.0V		1.5	-	-	V
		V_{CC}=4.5V		3.15	-	-	V
		V_{CC}=6.0V		4.2	-	-	V
LOW-level input voltage	V_{IL}	V_{CC}=2.0V		-	-	0.5	V
		V_{CC}=4.5V		-	-	1.35	V
		V_{CC}=6.0V		-	-	1.8	V
HIGH-level output voltage	V_{OH}	$V_I = V_{IH}$ or V_{IL}	I_O=-20uA; V_{CC}=2.0V	1.9	-	-	V
			I_O=-20uA; V_{CC}=4.5V	4.4	-	-	V
			I_O=-20uA; V_{CC}=6.0V	5.9	-	-	V
			I_O=-4.0mA; V_{CC}=4.5V	3.7	-	-	V
			I_O=-5.2mA; V_{CC}=6.0V	5.2	-	-	V
LOW-level output voltage	V_{OL}	$V_I = V_{IH}$ or V_{IL}	I_O=20uA; V_{CC}=2.0V	-	-	0.1	V
			I_O=20uA; V_{CC}=4.5V	-	-	0.1	V
			I_O=20uA; V_{CC}=6.0V	-	-	0.1	V
			I_O=4.0mA; V_{CC}=4.5V	-	-	0.4	V
			I_O=5.2mA; V_{CC}=6.0V	-	-	0.4	V
input leakage current	I_I	V_I=V_{CC} or GND; V_{CC}=6.0V		-	-	±1.0	uA
supply current	I_{CC}	V_I=V_{CC} or GND; I_O=0A; V_{CC}=6.0V		-	-	160	uA
AiP74HCT191							
HIGH-level input voltage	V_{IH}	V_{CC}=4.5V to 5.5V		2.0	-	-	V
LOW-level input voltage	V_{IL}	V_{CC}=4.5V to 5.5V		-	-	0.8	V
HIGH-level output voltage	V_{OH}	$V_I = V_{IH}$ or V_{IL}; V_{CC}=4.5V	I_O=-20uA	4.4	-	-	V
			I_O=-4.0mA	3.7	-	-	V
LOW-level output voltage	V_{OL}	$V_I = V_{IH}$ or V_{IL}; V_{CC}=4.5V	I_O=20uA	-	-	0.1	V
			I_O=4.0mA	-	-	0.4	V
input leakage current	I_I	V_I=V_{CC} or GND; V_{CC}=5.5V		-	-	±1.0	uA
supply current	I_{CC}	V_I=V_{CC} or GND; I_O=0A; V_{CC}=5.5V		-	-	160	uA
additional supply current	ΔI_{CC}	V_I=V_{CC}-2.1V; other inputs at V_{CC} or GND; I_O=0A; V_{CC}=4.5V to 5.5V		-	-	490	uA

3.3.4、AC Characteristics 1

(T_{amb}=25℃, GND=0V; t_r=t_f=6ns; C_L=50pF, unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
AiP74HC191							
propagation delay	t_{pd}	CP to Qn; see Figure 9	V_{CC}=2.0V	-	72	220	ns
			V_{CC}=4.5V	-	26	44	ns
			V_{CC}=5.0V; C_L=15pF	-	22	-	ns
			V_{CC}=6.0V	-	21	37	ns
		CP to TC; see Figure 9	V_{CC}=2.0V	-	83	255	ns
			V_{CC}=4.5V	-	30	51	ns
			V_{CC}=6.0V	-	24	43	ns
		CP to $\overline{RC}$; see Figure 10	V_{CC}=2.0V	-	47	150	ns
			V_{CC}=4.5V	-	17	30	ns
			V_{CC}=6.0V	-	14	26	ns
		$\overline{CE}$ to $\overline{RC}$; see Figure 10	V_{CC}=2.0V	-	33	130	ns
			V_{CC}=4.5V	-	12	26	ns
			V_{CC}=6.0V	-	10	22	ns
		Dn to Qn; see Figure 11	V_{CC}=2.0V	-	61	220	ns
			V_{CC}=4.5V	-	22	44	ns
			V_{CC}=6.0V	-	18	37	ns
		$\overline{PL}$ to Qn; see Figure 12	V_{CC}=2.0V	-	61	220	ns
			V_{CC}=4.5V	-	22	44	ns
			V_{CC}=6.0V	-	18	37	ns
		$\overline{U}$/D to TC; see Figure 13	V_{CC}=2.0V	-	44	190	ns
			V_{CC}=4.5V	-	16	38	ns
			V_{CC}=6.0V	-	13	32	ns
		$\overline{U}$/D to $\overline{RC}$; see Figure 13	V_{CC}=2.0V	-	50	210	ns
			V_{CC}=4.5V	-	18	42	ns
			V_{CC}=6.0V	-	14	36	ns
transition time	t_t	see Figure 14	V_{CC}=2.0V	-	19	75	ns
			V_{CC}=4.5V	-	7	15	ns
			V_{CC}=6.0V	-	6	13	ns
pulse width	t_W	CP; HIGH or LOW; see Figure 9	V_{CC}=2.0V	125	28	-	ns
			V_{CC}=4.5V	25	10	-	ns
			V_{CC}=6.0V	21	8	-	ns
		$\overline{PL}$; LOW; see Figure 14	V_{CC}=2.0V	100	22	-	ns
			V_{CC}=4.5V	20	8	-	ns
			V_{CC}=6.0V	17	6	-	ns
recovery time	t_{rec}	$\overline{PL}$ to CP; see Figure 14	V_{CC}=2.0V	35	8	-	ns
			V_{CC}=4.5V	7	3	-	ns
			V_{CC}=6.0V	6	2	-	ns
set-up time	t_{su}	$\overline{U}$/D to CP; see Figure 15	V_{CC}=2.0V	205	50	-	ns
			V_{CC}=4.5V	41	18	-	ns
			V_{CC}=6.0V	35	14	-	ns
		Dn to $\overline{PL}$;	V_{CC}=2.0V	100	19	-	ns

Parameter	Symbol	Condition		Min	Typ	Max	Unit
		see Figure 16	V_{CC}=4.5V	20	7	-	ns
			V_{CC}=6.0V	17	6	-	ns
		$\overline{CE}$ to CP; see Figure 15	V_{CC}=2.0V	140	44	-	ns
			V_{CC}=4.5V	28	16	-	ns
			V_{CC}=6.0V	24	13	-	ns
hold time	t_h	$\overline{U}$/D to CP; see Figure 15	V_{CC}=2.0V	0	-39	-	ns
			V_{CC}=4.5V	0	-14	-	ns
			V_{CC}=6.0V	0	-11	-	ns
		Dn to $\overline{PL}$; see Figure 16	V_{CC}=2.0V	0	-11	-	ns
			V_{CC}=4.5V	0	-4	-	ns
			V_{CC}=6.0V	0	-3	-	ns
		$\overline{CE}$ to CP; see Figure 15	V_{CC}=2.0V	0	-28	-	ns
			V_{CC}=4.5V	0	-10	-	ns
			V_{CC}=6.0V	0	-8	-	ns
maximum frequency	f_{max}	CP; see Figure 9	V_{CC}=2.0V	4.0	11	-	MHz
			V_{CC}=4.5V	20	33	-	MHz
			V_{CC}=5.0V; C_L=15pF	-	36	-	MHz
			V_{CC}=6.0V	24	39	-	MHz
power dissipation capacitance	C_{PD}	V_I=GND to V_{CC}		-	31	-	pF
AiP74HCT191							
propagation delay	t_{pd}	CP to Qn; see Figure 9	V_{CC}=4.5V	-	26	48	ns
			V_{CC}=5.0V; C_L=15pF	-	22	-	ns
		CP to TC; see Figure 9	V_{CC}=4.5V	-	32	51	ns
		CP to $\overline{RC}$; see Figure 10	V_{CC}=4.5V	-	19	35	ns
		$\overline{CE}$ to $\overline{RC}$; see Figure 10	V_{CC}=4.5V	-	19	33	ns
		Dn to Qn; see Figure 11	V_{CC}=4.5V	-	22	44	ns
		$\overline{PL}$ to Qn; see Figure 12	V_{CC}=4.5V	-	27	46	ns
		$\overline{U}$/D to TC; see Figure 13	V_{CC}=4.5V	-	23	45	ns
		$\overline{U}$/D to $\overline{RC}$; see Figure 13	V_{CC}=4.5V	-	24	45	ns
transition time	t_t	V_{CC}=4.5V; see Figure 14		-	7	15	ns
pulse width	t_W	CP; HIGH or LOW; V_{CC}=4.5V see Figure 9		16	9	-	ns
		$\overline{PL}$; LOW; V_{CC}=4.5V; see Figure 14		22	11	-	ns
recovery time	t_{rec}	$\overline{PL}$ to CP; V_{CC}=4.5V; see Figure 14		7	1	-	ns
set-up time	t_{su}	$\overline{U}$/D to CP; V_{CC}=4.5V; see Figure 15		41	20	-	ns
		Dn to $\overline{PL}$; V_{CC}=4.5V; see Figure 16		20	9	-	ns
		$\overline{CE}$ to CP; V_{CC}=4.5V;see Figure 15		30	18	-	ns

				Min.	Typ.	Max.	Unit
hold time	t_h	$\overline{U}/D$ to CP; V_{CC}=4.5V; see Figure 15		0	-18	-	ns
		Dn to $\overline{PL}$; V_{CC}=4.5V; see Figure 16		0	-5	-	ns
		$\overline{CE}$ to CP; V_{CC}=4.5V;see Figure 15		0	-10	-	ns
maximum frequency	f_{max}	CP; see Figure 9	V_{CC}=4.5V	20	33	-	MHz
			V_{CC}=5.0V; C_L=15pF	-	36	-	MHz
power dissipation capacitance	C_{PD}	V_I=GND to V_{CC}-1.5V		-	33	-	pF

Note:

[1] t_{pd} is the same as t_{PLH} and t_{PHL}.

[2] t_t is the same as t_{THL} and t_{TLH}.

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in uW).

$P_D=C_{PD}\times V_{CC}^2\times f_i\times N+\sum(C_L\times V_{CC}^2\times f_o)$ where:

f_i=input frequency in MHz;

f_o=output frequency in MHz;

C_L=output load capacitance in pF;

V_{CC}=supply voltage in V;

N=number of inputs switching;

$\sum(C_L\times V_{CC}^2\times f_o)$=sum of outputs.

3.3.5、AC Characteristics 2

(T_{amb}=-40℃ to +85℃, GND=0V; t_r=t_f=6ns; C_L=50pF, unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
AiP74HC191							
propagation delay	t_{pd}	CP to Qn; see Figure 9	V_{CC}=2.0V	-	-	275	ns
			V_{CC}=4.5V	-	-	55	ns
			V_{CC}=6.0V	-	-	47	ns
		CP to TC; see Figure 9	V_{CC}=2.0V	-	-	320	ns
			V_{CC}=4.5V	-	-	64	ns
			V_{CC}=6.0V	-	-	54	ns
		CP to $\overline{RC}$; see Figure 10	V_{CC}=2.0V	-	-	190	ns
			V_{CC}=4.5V	-	-	38	ns
			V_{CC}=6.0V	-	-	33	ns
		$\overline{CE}$ to $\overline{RC}$; see Figure 10	V_{CC}=2.0V	-	-	165	ns
			V_{CC}=4.5V	-	-	33	ns
			V_{CC}=6.0V	-	-	28	ns
		Dn to Qn; see Figure 11	V_{CC}=2.0V	-	-	275	ns
			V_{CC}=4.5V	-	-	55	ns
			V_{CC}=6.0V	-	-	47	ns
		$\overline{PL}$ to Qn; see Figure 12	V_{CC}=2.0V	-	-	275	ns
			V_{CC}=4.5V	-	-	55	ns
			V_{CC}=6.0V	-	-	47	ns
		$\overline{U}/D$ to TC; see Figure 13	V_{CC}=2.0V	-	-	240	ns
			V_{CC}=4.5V	-	-	48	ns
			V_{CC}=6.0V	-	-	41	ns

		$\overline{\text{U}}$/D to $\overline{\text{RC}}$; see Figure 13	V_{CC}=2.0V	-	-	265	ns
			V_{CC}=4.5V	-	-	53	ns
			V_{CC}=6.0V	-	-	45	ns
transition time	t_t	see Figure 14	V_{CC}=2.0V	-	-	95	ns
			V_{CC}=4.5V	-	-	19	ns
			V_{CC}=6.0V	-	-	16	ns
pulse width	t_W	CP; HIGH or LOW; see Figure 9	V_{CC}=2.0V	155	-	-	ns
			V_{CC}=4.5V	31	-	-	ns
			V_{CC}=6.0V	26	-	-	ns
		$\overline{\text{PL}}$; LOW; see Figure 14	V_{CC}=2.0V	125	-	-	ns
			V_{CC}=4.5V	25	-	-	ns
			V_{CC}=6.0V	21	-	-	ns
recovery time	t_{rec}	$\overline{\text{PL}}$ to CP; see Figure 14	V_{CC}=2.0V	45	-	-	ns
			V_{CC}=4.5V	9	-	-	ns
			V_{CC}=6.0V	8	-	-	ns
set-up time	t_{su}	$\overline{\text{U}}$/D to CP; see Figure 15	V_{CC}=2.0V	255	-	-	ns
			V_{CC}=4.5V	51	-	-	ns
			V_{CC}=6.0V	43	-	-	ns
		Dn to $\overline{\text{PL}}$; see Figure 16	V_{CC}=2.0V	125	-	-	ns
			V_{CC}=4.5V	25	-	-	ns
			V_{CC}=6.0V	21	-	-	ns
		$\overline{\text{CE}}$ to CP; see Figure 15	V_{CC}=2.0V	175	-	-	ns
			V_{CC}=4.5V	35	-	-	ns
			V_{CC}=6.0V	30	-	-	ns
hold time	t_h	$\overline{\text{U}}$/D to CP; see Figure 15	V_{CC}=2.0V	0	-	-	ns
			V_{CC}=4.5V	0	-	-	ns
			V_{CC}=6.0V	0	-	-	ns
		Dn to $\overline{\text{PL}}$; see Figure 16	V_{CC}=2.0V	0	-	-	ns
			V_{CC}=4.5V	0	-	-	ns
			V_{CC}=6.0V	0	-	-	ns
		$\overline{\text{CE}}$ to CP; see Figure 15	V_{CC}=2.0V	0	-	-	ns
			V_{CC}=4.5V	0	-	-	ns
			V_{CC}=6.0V	0	-	-	ns
maximum frequency	f_{max}	CP; see Figure 9	V_{CC}=2.0V	3.2	-	-	MHz
			V_{CC}=4.5V	16	-	-	MHz
			V_{CC}=6.0V	19	-	-	MHz
AiP74HCT191							
propagation delay	t_{pd}	CP to Qn; see Figure 9	V_{CC}=4.5V	-	-	60	ns
		CP to TC; see Figure 9	V_{CC}=4.5V	-	-	64	ns
		CP to $\overline{\text{RC}}$; see Figure 10	V_{CC}=4.5V	-	-	44	ns
		$\overline{\text{CE}}$ to $\overline{\text{RC}}$; see Figure 10	V_{CC}=4.5V	-	-	41	ns
		Dn to Qn;	V_{CC}=4.5V	-	-	55	ns

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
		see Figure 11					
		$\overline{PL}$ to Qn; see Figure 12	V_{CC}=4.5V	-	-	58	ns
		$\overline{U/D}$ to TC; see Figure 13	V_{CC}=4.5V	-	-	56	ns
		$\overline{U/D}$ to $\overline{RC}$; see Figure 13	V_{CC}=4.5V	-	-	56	ns
transition time	t_t	V_{CC}=4.5V; see Figure 14		-	-	19	ns
pulse width	t_W	CP; HIGH or LOW; V_{CC}=4.5V see Figure 9		20	-	-	ns
		$\overline{PL}$; LOW; V_{CC}=4.5V; see Figure 14		28	-	-	ns
recovery time	t_{rec}	$\overline{PL}$ to CP; V_{CC}=4.5V; see Figure 14		9	-	-	ns
set-up time	t_{su}	$\overline{U/D}$ to CP; V_{CC}=4.5V; see Figure 15		51	-	-	ns
		Dn to $\overline{PL}$; V_{CC}=4.5V; see Figure 16		25	-	-	ns
		$\overline{CE}$ to CP; V_{CC}=4.5V;see Figure 15		38	-	-	ns
hold time	t_h	$\overline{U/D}$ to CP; V_{CC}=4.5V; see Figure 15		0	-	-	ns
		Dn to $\overline{PL}$; V_{CC}=4.5V; see Figure 16		0	-	-	ns
		$\overline{CE}$ to CP; V_{CC}=4.5V;see Figure 15		0	-	-	ns
maximum frequency	f_{max}	CP; see Figure 9	V_{CC}=4.5V	16	-	-	MHz

Note:

[1] t_{pd} is the same as t_{PLH} and t_{PHL}.

[2] t_t is the same as t_{THL} and t_{TLH}.

3.3.6、AC Characteristics 3

(T_{amb}=-40℃ to +125℃, GND=0V; t_r=t_f=6ns; C_L=50pF, unless otherwise specified.)

Parameter	Symbol	Conditions		Min.	Typ.	Max.	Unit
AiP74HC191							
propagation delay	t_{pd}	CP to Qn; see Figure 9	V_{CC}=2.0V	-	-	330	ns
			V_{CC}=4.5V	-	-	66	ns
			V_{CC}=6.0V	-	-	56	ns
		CP to TC; see Figure 9	V_{CC}=2.0V	-	-	395	ns
			V_{CC}=4.5V	-	-	77	ns
			V_{CC}=6.0V	-	-	65	ns
		CP to $\overline{RC}$; see Figure 10	V_{CC}=2.0V	-	-	225	ns
			V_{CC}=4.5V	-	-	45	ns
			V_{CC}=6.0V	-	-	38	ns
		$\overline{CE}$ to $\overline{RC}$; see Figure 10	V_{CC}=2.0V	-	-	195	ns
			V_{CC}=4.5V	-	-	39	ns
			V_{CC}=6.0V	-	-	33	ns
		Dn to Qn; see Figure 11	V_{CC}=2.0V	-	-	330	ns
			V_{CC}=4.5V	-	-	66	ns
			V_{CC}=6.0V	-	-	56	ns
		$\overline{PL}$ to Qn;	V_{CC}=2.0V	-	-	330	ns

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		see Figure 12	V_{CC}=4.5V	-	-	66	ns
			V_{CC}=6.0V	-	-	56	ns
		$\overline{U}$/D to TC; see Figure 13	V_{CC}=2.0V	-	-	285	ns
			V_{CC}=4.5V	-	-	57	ns
			V_{CC}=6.0V	-	-	48	ns
		$\overline{U}$/D to $\overline{RC}$; see Figure 13	V_{CC}=2.0V	-	-	315	ns
			V_{CC}=4.5V	-	-	63	ns
			V_{CC}=6.0V	-	-	54	ns
transition time	t_t	see Figure 14	V_{CC}=2.0V	-	-	110	ns
			V_{CC}=4.5V	-	-	22	ns
			V_{CC}=6.0V	-	-	19	ns
pulse width	t_W	CP; HIGH or LOW; see Figure 9	V_{CC}=2.0V	195	-	-	ns
			V_{CC}=4.5V	39	-	-	ns
			V_{CC}=6.0V	33	-	-	ns
		$\overline{PL}$; LOW; see Figure 14	V_{CC}=2.0V	150	-	-	ns
			V_{CC}=4.5V	30	-	-	ns
			V_{CC}=6.0V	26	-	-	ns
recovery time	t_{rec}	$\overline{PL}$ to CP; see Figure 14	V_{CC}=2.0V	55	-	-	ns
			V_{CC}=4.5V	11	-	-	ns
			V_{CC}=6.0V	9	-	-	ns
set-up time	t_{su}	$\overline{U}$/D to CP; see Figure 15	V_{CC}=2.0V	310	-	-	ns
			V_{CC}=4.5V	62	-	-	ns
			V_{CC}=6.0V	53	-	-	ns
		Dn to $\overline{PL}$; see Figure 16	V_{CC}=2.0V	150	-	-	ns
			V_{CC}=4.5V	30	-	-	ns
			V_{CC}=6.0V	26	-	-	ns
		$\overline{CE}$ to CP; see Figure 15	V_{CC}=2.0V	210	-	-	ns
			V_{CC}=4.5V	42	-	-	ns
			V_{CC}=6.0V	36	-	-	ns
hold time	t_h	$\overline{U}$/D to CP; see Figure 15	V_{CC}=2.0V	0	-	-	ns
			V_{CC}=4.5V	0	-	-	ns
			V_{CC}=6.0V	0	-	-	ns
		Dn to $\overline{PL}$; see Figure 16	V_{CC}=2.0V	0	-	-	ns
			V_{CC}=4.5V	0	-	-	ns
			V_{CC}=6.0V	0	-	-	ns
		$\overline{CE}$ to CP; see Figure 15	V_{CC}=2.0V	0	-	-	ns
			V_{CC}=4.5V	0	-	-	ns
			V_{CC}=6.0V	0	-	-	ns
maximum frequency	f_{max}	CP; see Figure 9	V_{CC}=2.0V	2.6	-	-	MHz
			V_{CC}=4.5V	13	-	-	MHz
			V_{CC}=6.0V	15	-	-	MHz
AiP74HCT191							
propagation delay	t_{pd}	CP to Qn; see Figure 9	V_{CC}=4.5V	-	-	72	ns
		CP to TC; see Figure 9	V_{CC}=4.5V	-	-	77	ns

		$\overline{CP}$ to $\overline{RC}$; see Figure 10	V_{CC}=4.5V	-	-	53	ns
		$\overline{CE}$ to $\overline{RC}$; see Figure 10	V_{CC}=4.5V	-	-	50	ns
		Dn to Qn; see Figure 11	V_{CC}=4.5V	-	-	66	ns
		$\overline{PL}$ to Qn; see Figure 12	V_{CC}=4.5V	-	-	69	ns
		$\overline{U}$/D to TC; see Figure 13	V_{CC}=4.5V	-	-	68	ns
		$\overline{U}$/D to $\overline{RC}$; see Figure 13	V_{CC}=4.5V	-	-	68	ns
transition time	t_t	V_{CC}=4.5V; see Figure 14		-	-	22	ns
pulse width	t_W	CP; HIGH or LOW; V_{CC}=4.5V see Figure 9		24	-	-	ns
		$\overline{PL}$; LOW; V_{CC}=4.5V; see Figure 14		33	-	-	ns
recovery time	t_{rec}	$\overline{PL}$ to CP; V_{CC}=4.5V; see Figure 14		11	-	-	ns
set-up time	t_{su}	$\overline{U}$/D to CP; V_{CC}=4.5V; see Figure 15		62	-	-	ns
		Dn to $\overline{PL}$; V_{CC}=4.5V; see Figure 16		30	-	-	ns
		$\overline{CE}$ to CP; V_{CC}=4.5V;see Figure 15		45	-	-	ns
hold time	t_h	$\overline{U}$/D to CP; V_{CC}=4.5V; see Figure 15		0	-	-	ns
		Dn to $\overline{PL}$; V_{CC}=4.5V; see Figure 16		0	-	-	ns
		$\overline{CE}$ to CP; V_{CC}=4.5V;see Figure 15		0	-	-	ns
maximum frequency	f_{max}	CP; see Figure 9	V_{CC}=4.5V	13	-	-	MHz

Note:

[1] t_{pd} is the same as t_{PLH} and t_{PHL}.

[2] t_t is the same as t_{THL} and t_{TLH}.

4、Testing Circuit

4.1、AC Testing Circuit
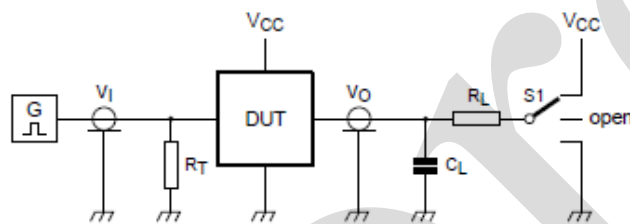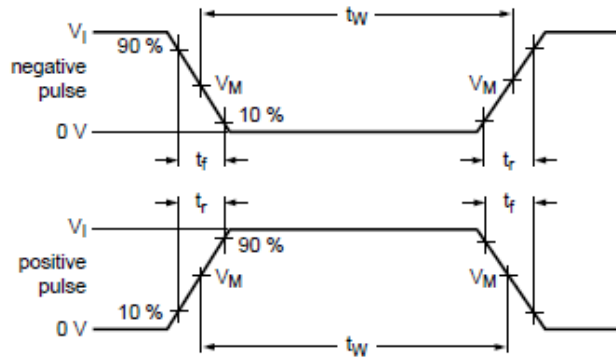
Figure 8. Test circuit for measuring switching times

Definitions for test circuit:

C_L=Load capacitance including jig and probe capacitance.

R_T=Termination resistance should be equal to the output impedance Z_o of the pulse generator.

R_L=Load resistance.

S1=Test selection switch

4.2、AC Testing Waveforms
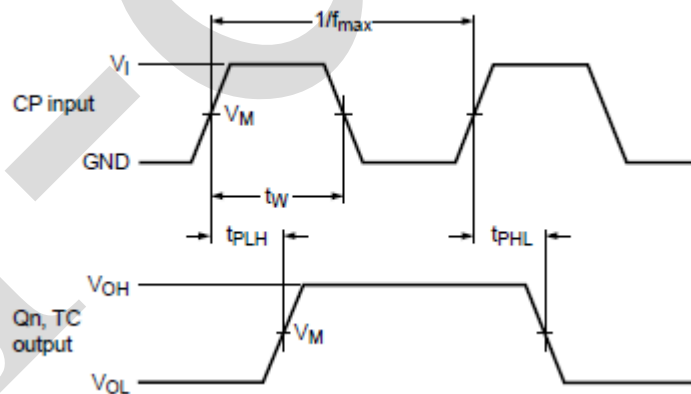
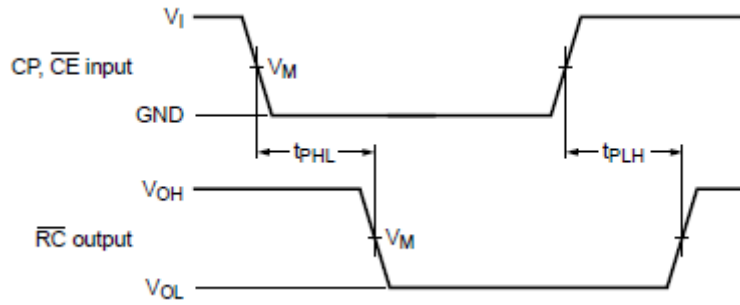Figure 9. The clock input (CP) to outputs (Qn, TC) propagation delays, clock pulse width and maximum clock frequency

Figure 10. The clock and count enable inputs (CP, $\overline{CE}$) to ripple clock output ($\overline{RC}$) propagation delays
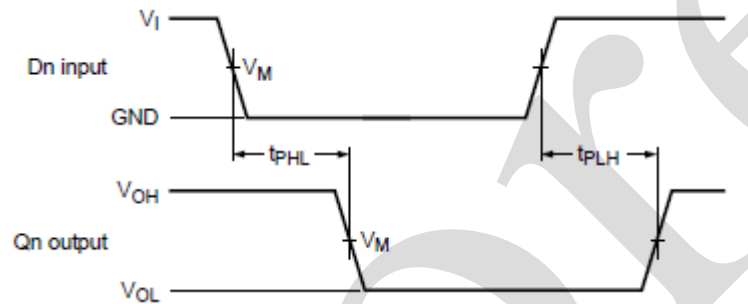
Figure 11. The input (Dn) to output (Qn) propagation delays
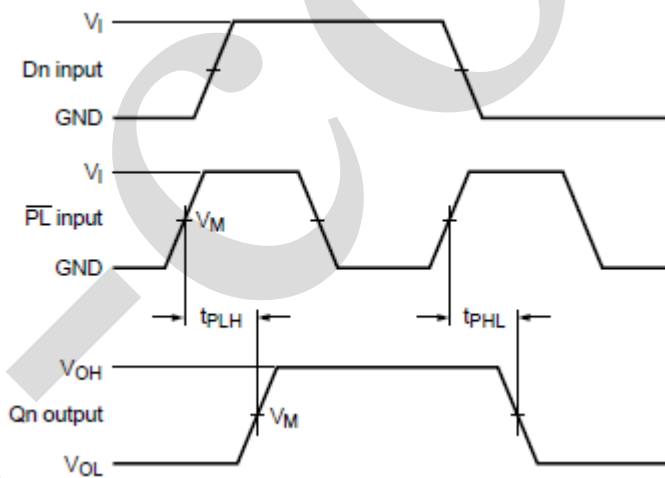
Figure 12. The parallel load input ($\overline{PL}$) to output (Qn) propagation delays
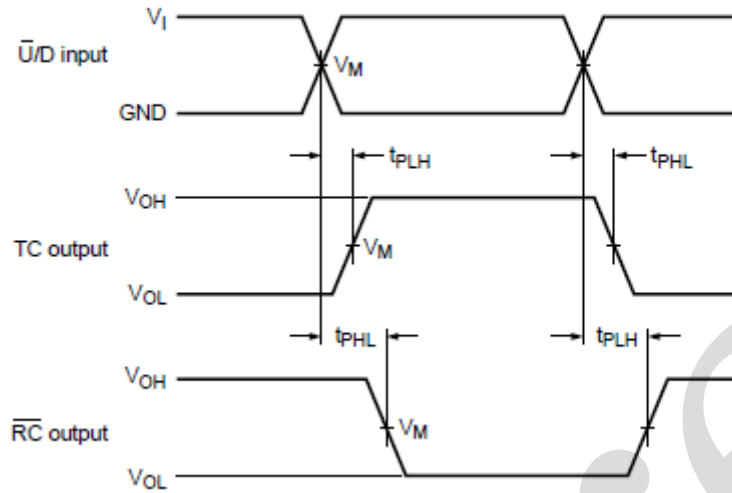
Figure 13. The up/down count input ($\overline{U}$/D) to terminal count and ripple clock output (TC, $\overline{RC}$) propagation delays
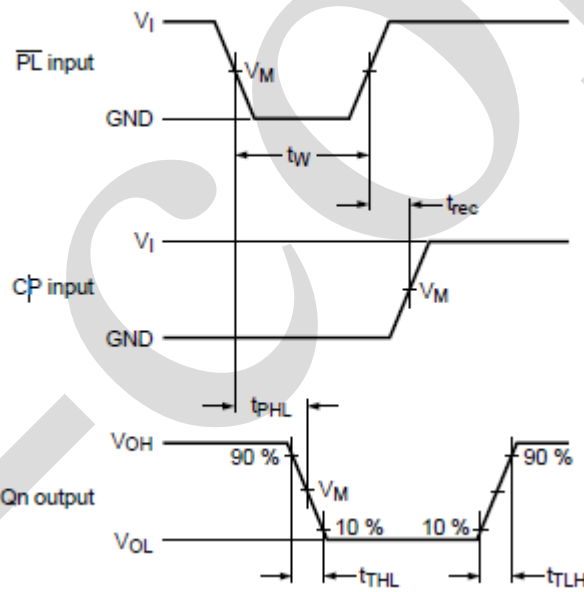
Figure 14. The parallel load input ($\overline{PL}$) to clock (CP) recovery times, parallel load pulse width and output (Qn) transition times
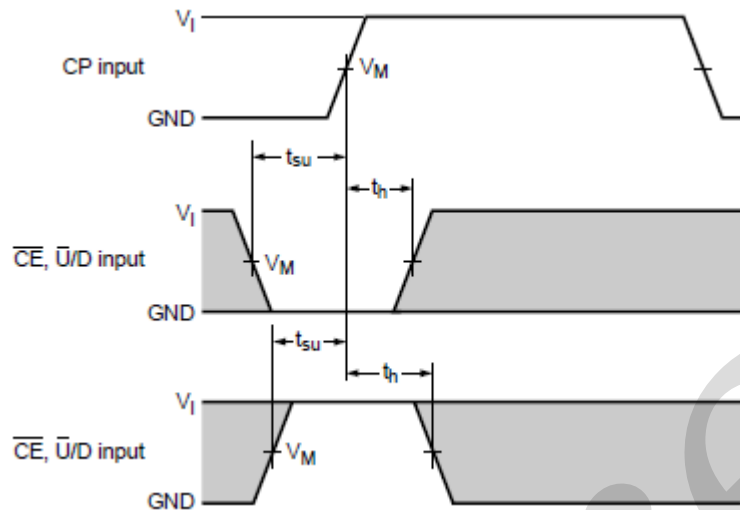
Figure 15. The count enable and up/down count inputs ($\overline{\text{CE}}$, $\overline{\text{U}}$/D) to clock input (CP) set-up and hold times
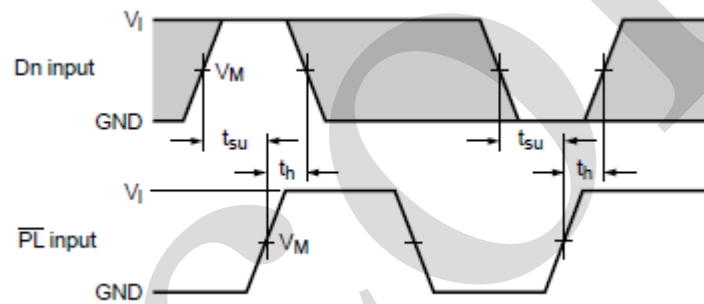
Figure 16. The parallel load input ($\overline{\text{PL}}$) to data input (Dn) set-up and hold times

4.3、Measurement Points

Type	Input	Output
	V_M	V_M
AiP74HC191	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$
AiP74HCT191	1.3V	1.3V

4.4、Test Data

Type	Input		Load		S1 position
	V_I	t_r , t_f	C_L	R_L	t_{PLH}, t_{PHL}
AiP74HC191	V_{CC}	6ns	15pF, 50pF	1kΩ	open
AiP74HCT191	3V	6ns	15pF, 50pF	1kΩ	open

5、Package Information

5.1、DIP16
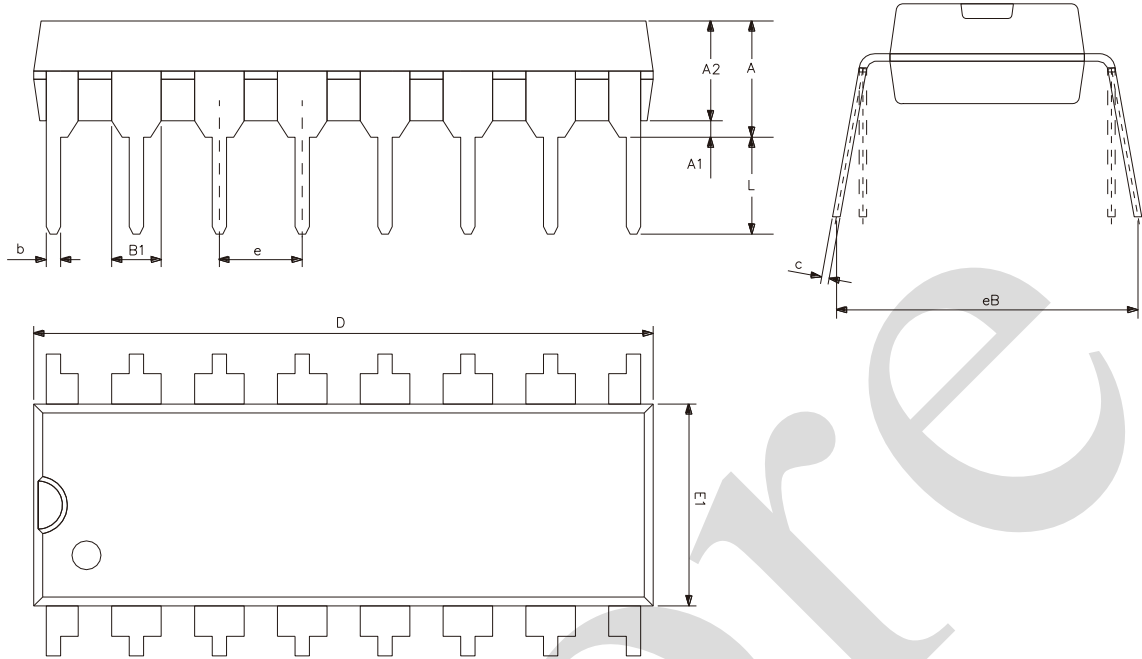
Symbol	Dimensions (mm)	
	Min.	**Max.**
A2	3.20	3.60
A1	0.51	-
A	3.60	5.33
L	3.00	3.60
b	0.36	0.56
B1	1.52	
D	18.80	19.94
E1	6.20	6.60
e	2.54	
c	0.20	0.36
eB	7.62	9.30

5.2、SOP16
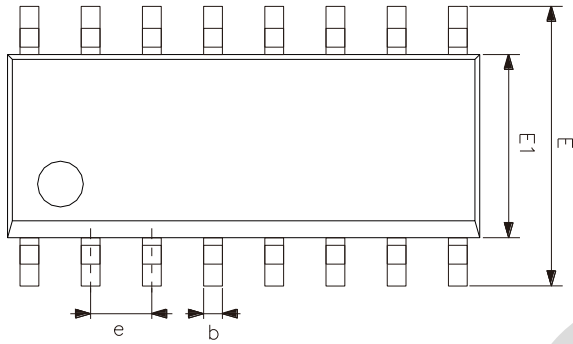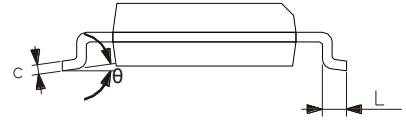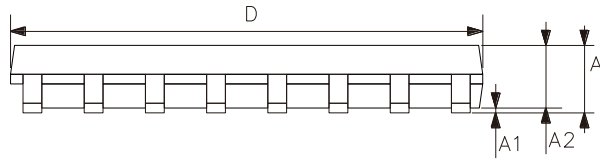
Symbol	Dimensions (mm)	
	Min.	Max.
A	1.35	1.80
A1	0.10	0.25
A2	1.25	1.55
b	0.33	0.51
c	0.19	0.25
D	9.50	10.10
E	5.80	6.30
E1	3.70	4.10
e	1.27	
L	0.35	0.89
θ	0°	8°

5.3、TSSOP16
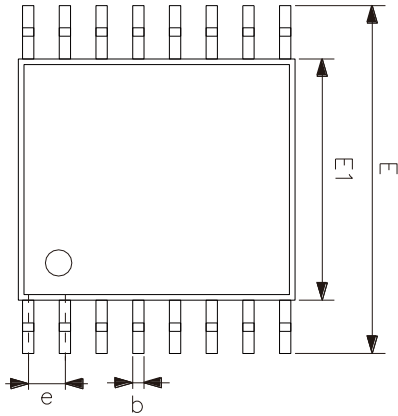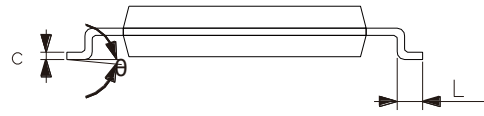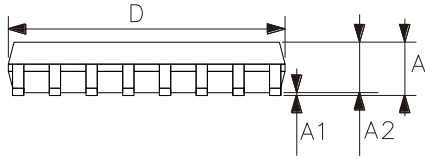
Symbol	Dimensions (mm)	
	Min.	Max.
A	-	1.20
A1	0.05	0.15
A2	0.80	1.05
b	0.19	0.30
c	0.09	0.20
D	4.90	5.10
E1	4.30	4.50
E	6.20	6.60
e	0.65	
L	0.45	0.75
θ	0°	8°

6、Statements And Notes

6.1、The name and content of Hazardous substances or Elements in the product

Part name	Hazardous substances or Elements									
	Lead and lead compounds	Mercury and mercury compounds	Cadmium and cadmium compounds	Hexavalent chromium compounds	Polybrominated biphenyls	Polybrominated biphenyl ethers	Dibutyl phthalate	Butylbenzyl phthalate	Di-2-ethylhexyl phthalate	Diisobutyl phthalate
Lead frame	○	○	○	○	○	○	○	○	○	○
Plastic resin	○	○	○	○	○	○	○	○	○	○
Chip	○	○	○	○	○	○	○	○	○	○
The lead	○	○	○	○	○	○	○	○	○	○
Plastic sheet installed	○	○	○	○	○	○	○	○	○	○
explanation	○：Indicates that the content of hazardous substances or elements in the detection limit of the following the SJ/T11363-2006 standard. ×：Indicates that the content of hazardous substances or elements exceeding the SJ/T11363-2006 Standard limit requirements.									

6.2、Notes

We Recommend you to read this chapter carefully before using this product.

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